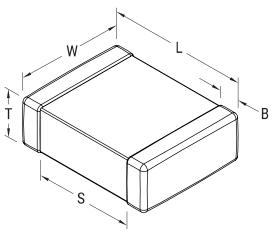




ESD SMD Comm X7R, Ceramic, 0.047 uF, 10%, 63 VDC, X7R, SMD, MLCC, Temperature Stable, Electro Static Discharge, Class II, 1.5 mm, 1206 / 3216



Click here for the 3D model.

Dimensions	
L	3.2mm +/-0.2mm
W	1.6mm +/-0.2mm
Т	1mm +/-0.10mm
S	1.5mm MIN
В	0.5mm +/-0.25mm
Case Code (EIA / mm)	1206 / 3216

Packaging Specifications		
Packaging	Bulk, Bag	
Packaging Quantity	1	

General Information	
Series	ESD SMD Comm X7R
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Electro Static Discharge, Class II
Features	Temperature Stable, Class II
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	25 mg
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	0.047 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	63 VDC
ESD Level per AEC-Q200	25,000 V ESD Level
Dielectric Withstanding Voltage	157.5 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5% 1 kHz 1.0 Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	21.2766 GOhms

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